

# WTXS0102 2-Bit Bidirectional Voltage-Level Translator

## Description

This two-bit non-inverting translator which is a bidirectional voltage-level translator and can be used to build digital switching compatibility between multi voltage systems. This IC uses two separate configurable power supply tracks that including A ports supporting operating voltages from 1.65 V to 3.6 V with tracking V<sub>CCA</sub> supply, and also including B ports supporting operating voltages from 2.3 V to 5.5 V with tracking V<sub>CCB</sub> supply.

The advantage above provides the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage circuit points.

Placing output-enable (OE) input to low level, all I/Os are forced to high-impedance state that significantly lower the quiescent current consumption. In order to ensure the high-impedance state during power up or power down, OE pin should be tied to GND via a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

## Features

No direction -control
Data rates
24 Mbps (Push Pull)
2 Mbps (Open Drain)

- 1.65 V to 3.6 V on A port and 2.3 V to 5.5 V

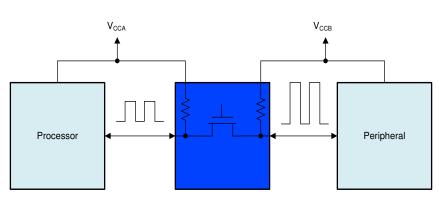
VCC isolation feature: If either VCC input is at GND, both ports are in the high -impedance state
No power -supply sequencing required: either V <sub>CCA</sub> or V <sub>CCB</sub> can be ramped first
I<sub>off</sub> supports partial -power -down mode operation
Operating temperature range: -40°C to +85°C

on B port (V <sub>CCA</sub> ≤ V<sub>CCB</sub>)

# Applications

- Handset/Smartphone
- MART
- IPC
- GPIO

# **Circuit Diagram**



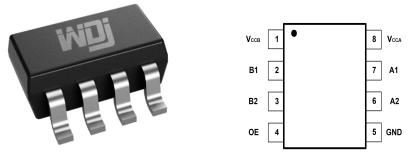




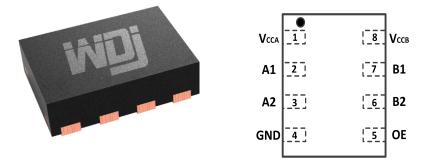
## Order information

Package	Orderable Device	PackingQty	Body Size	Marking
SOT23-8	WTXS0102YH8	Tape and Reel,3000	2.92mm x 2.80mm	0102
DFN1.4*1-8L	WTXS0102DQER	Tape and Reel,5000	1.40mm x 1.00mm	0102
VSSOP-8	WTXS0102DCUR	Tape and Reel,3000	2.00mm x 2.30mm	0102

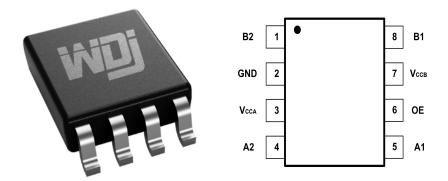
# **Device Summary, Pin and Packages**



WTXS0102 : YH8 (SOT23-8) Package



# WTXS0102 : DQER (DFN1.4\*1-8L) Package



# WTXS0102 : DCUR(VSSOP-8) Package



### Device Summary, Pin and Packages (Continued)

		-			
F	Pin			I/O	Function
Name	YH8	DQER	DCUR		
VCCB	1	8	7	-	B Port Supply Voltage. 2.3V≤Vccв.≤5.5V
B1	2	7	8	I/O	Input/Output B1. Referenced to VCCB.
B2	3	6	1	I/O	Input/Output B2. Referenced to VCCB.
OE	4	5	6	I	Output Enable (Active High).Pull OE low to place all outputs in 3-state mode. Referenced to VCCA.
GND	5	4	2	-	Ground
A2	6	3	4	I/O	Input/Output A2. Referenced to VCCA.
A1	7	2	5	I/O	Input/Output A1. Referenced to VCCA.
VCCA	8	1	3	-	A Port Supply Voltage. 1.65V≤VCCA.≤3.6V and VCCA.≤VCCB.

\*It is suggested to leave the unconnected pins floating.

### **Absolute Maximum Ratings**

Parameters	Parameters			
Supply voltage, Vcca	Supply voltage, Vcca			V
Supply voltage, Vссв		-0.3	6.0	V
	A port	-0.3	6.0	V
Input voltage range,Vı	-0.3	6.0	v	
Voltage range applied to any output in the high-impedance or	-0.3	6.0	V	
power-off state, Vo	B port	-0.3	6.0	v
Voltage range applied to any output in the high or law state. Ve	A port	-0.3	V <sub>CCA</sub> +0.3	V
Voltage range applied to any output in the high or low state, Vo	B port	-0.3	V <sub>CCA</sub> +0.3	v
Input clamp current,I <sub>IK</sub>	<b>V</b> I<0		-50	mA
Output clamp current,l <sub>ok</sub>	Vo<0		-50	mA
Continuous output current, lo			±50	mA
Continuous current through VccA, VccB or GND	Continuous current through Vсса, Vссв or GND			
Maximum junction temperature			150	°C
Storage temperature range		-65	150	°C

(1)Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed

(3) The value of  $V_{\text{CCA}}$  and  $V_{\text{CCB}}$  are provided in the recommended operating conditions table.

# **ESD** Ratings

	E	SD	Value	Unit
	V(ESD) Electrostatic Discharge	Human-Body Model (HBM) <sup>(1)</sup>	±5K	V
V(ESD)		Charged-Device Model (CDM) <sup>(2)</sup>	±2K	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



# **Recommended Operating Conditions**

Vccl is the supply voltage associated with the input port.Vcco is the supply Voltage associated with the output port.

Parameter	(	Conditions	Min	Тур	Max	Unit	
Supply voltons (1)		V <sub>CCA</sub>	1.65		3.6	M	
Supply voltage <sup>(1)</sup>		V <sub>CCB</sub>	2.3		5.5	V	
	A part 1/Op	V <sub>CCA</sub> =1.65 V to 1.95 V V <sub>CCB</sub> =2.3 V to 5.5 V	V <sub>CCI</sub> -0.2		Vcci		
High-level input voltage(Vıн)	A-port I/Os	V <sub>CCA</sub> =2.3 V to 3.6 V V <sub>CCB</sub> =2.3 V to 5.5 V	Vcci-0.4		Vcci		
	B-port I∕Os	$V_{CCA}$ =1.65 V to 3.6V V <sub>CCB</sub> =2.3 V to 5.5 V	Vcci-0.4		Vcci	V	
	OE input	V <sub>CCA</sub> =1.65 V to 3.6 V V <sub>CCB</sub> =2.3 V to 5.5 V	V <sub>CCI</sub> ×0.8		5.5		
Low-level	A-port I/Os	V <sub>CCA</sub> =1.65 V to 1.95 V V <sub>CCB</sub> =2.3 V to 5.5 V	0		0.15	V	
input voltage(VIL) <sup>(2)</sup>	B-port I/Os	V <sub>CCA=</sub> 1.65 V to 3.6 V V <sub>CCB</sub> =2.3 V to 5.5 V	0		0.15	V	
OE	OE input	V <sub>CCA</sub> =1.65 V to 3.6 V V <sub>CCB</sub> =2.3 V to 5.5 V	0		$V_{CCA} \times 0.25$	V	
Input transition rise	A-port I/Os	push-pull driving			10		
Input transition rise or fall rate(Δt/Δv)	B-port I/Os	push-pull driving			10	ns/V	
	Control input				10		
TA Operating free- air temperature		-40		85	°C		

(1)  $V_{\text{CCA}}$  must be less than or equal to  $V_{\text{CCB}}$ 

(2) The maximum  $V_{IL}$  value is provided to ensure that a valid  $V_{OL}$  is maintained. The  $V_{OL}$  value is  $V_{IL}$  plus the voltage drop across the pass gate transistor.





### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)  $^{(1)(2)(3)}$ 

Parameter		Conditions	Vcca	Vccb	Temp	Min	Тур	Max	Uni	
Voha	Port A Output High Voltage	I <sub>OH</sub> =–20 μA V <sub>IB</sub> ≥ V <sub>CCB</sub> – 0.4V	1.65V to 3.6V	1.65V to 3.6V 2.3V to 5.5V		Full V <sub>CCA</sub> ×0.7			V	
Vola	Port A Output Low Voltage	lo∟=1mA V <sub>IB</sub> ≤ 0.15 V	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V	
V <sub>OHB</sub>	Port B Output High Voltage	I <sub>OH</sub> =−20 μA V <sub>IA</sub> ≥ V <sub>CCA</sub> − 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V <sub>CCA</sub> ×0.7			V	
Volb	Port B Output Low Voltage	I <sub>0L</sub> =1mA V <sub>IA</sub> ≤ 0.15 V	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V	
h	Input Leakage	OE	1.65V to 3.6V	2.3V to 5.5V	+25℃			±1	μA	
	Current				Full			±1.5		
Partial Power		A Ports	ΟV	0V to 5.5V	<b>+25</b> ℃			±0.5		
	Power	, TT OILO			Full			±1	μA	
loff	Down Current		٥V	<b>+25</b> ℃			±0.5	μA		
		D FOILS	00 10 3.00	00	Full			±1		
	High-impedance	e Output OF-0V 1.65V to 3.6V 2.3V to 5.	2 2)/ to 5 5)/	<b>+25</b> ℃			±0.5	/		
loz	Current		OE=0V	2.30 10 5.50	Full			±1	μA	
			1.65V to V <sub>CCB</sub>	2.3v to 5.5V	Full			2.5		
ICCA	V <sub>CCA</sub> Supply Current	V⊨V₀=open I₀=0		3.6v	0V	Full			2.5	μA
			0v	5.5V	Full			-1		
			1.65V to $V_{CCB}$	2.3v to 5.5V	Full			10		
Іссв	V <sub>CCB</sub> Supply Current	V⊨V₀=open I₀=0	3.6v	0V	Full			-1	μA	
			0v	5.5V	Full			1		
cca + Iccb	Combined Supply Current	VI=V <sub>CCI</sub> or GND I <sub>O=</sub> 0	1.65V to V <sub>CCB</sub>	2.3v to 5.5V	Full			13	μA	
ICCZA	V <sub>CCA</sub> Supply Current	V <sub>I</sub> =V <sub>CCI</sub> or 0V I <sub>0</sub> =0, OE=0V	1.65V to V <sub>CCB</sub>	2.3v to 5.5V	Full			1	μA	
ICCZB	V <sub>CCB</sub> Supply Current	V <sub>I</sub> =V <sub>CCI</sub> or 0V I <sub>O</sub> =0, OE=0V	2.3v to 3.6V	2.3v to 5.5V	Full			1	μA	
Ci	Input Capacitance	OE	3.3V	3.3V	<b>+25</b> ℃		2.5		PF	
0	Input-to-output	A Port	3.3V	3.3V	<b>+25</b> ℃		5			
C <sub>io</sub> Internal Capacitance		B Port	3.3V	3.3V	<b>+25</b> ℃		5		PF	

(1) V<sub>CCI</sub> is the VCC associated with the input port.

(2)  $V_{\text{CCO}}$  is the VCC associated with the output port

(3)  $V_{\text{CCA}}$  must be less than or equal to  $V_{\text{CCB}}.$ 





# **Timing Requirements**

### $V_{\text{CCA}}\text{=}1.8V{\pm}0.15V$

		$V_{CCB}=2.5V\pm0.2V$	$V_{\text{CCB}}\text{=}3.3V{\pm}0.2V$	V <sub>ссв</sub> =5V±0.2V	Unit
		Тур	Тур	Тур	Unit
Data Rate	Push-pull Driving	21	22	24	Mhna
Data Rate	Open-drain Driving	2	2	2	Mbps
Pulse	Push-pull Driving (Data Inputs)	47	45	41	
Duration(tw)	Open-drain Driving (Data Inputs)	500	500	500	ns

#### Vcca=2.5V±0.15V

		V <sub>CCB</sub> =2.5V±0.2V	V <sub>CCB</sub> =3.3V±0.2V	V <sub>ссв</sub> =5V±0.2V	Unit
		Тур	Тур	Тур	Unit
Data Rate	Push-pull Driving	20	22	24	Mbps
Data Rale	Open-drain Driving	2	2	2	ivibps
Pulse	Push-pull Driving (Data Inputs)	50	45	41	
Duration(tw)	Open-drain Driving (Data Inputs)	500	500	500	ns

#### $V_{CCA}=3.3V\pm0.15V$

		V <sub>CCB</sub> =3.3V±0.2V	V <sub>CCB</sub> =5V±0.2V	11
		Тур	Тур	Unit
Data Rate	Push-pull Driving	23	24	Mbpo
Data Rate	Open-drain Driving	2	2	- Mbps
	Push-pull Driving (Data Inputs)	43	41	20
Pulse Duration(tw)	Open-drain Driving (Data Inputs)	500	500	- ns



# Switching Characteristics:Vcc=1.8V±0.15V

over recommended operating free-air temperature range (unless otherwise noted)

	Parameter		Conditions	$V_{ccB}=2.5V\pm0.2V$	$V_{ccB}$ =3.3V $\pm$ 0.2V	$V_{ccB}$ =5V $\pm$ 0.2V	Units	
	Farameter		Conditions	Тур	Тур	Тур	onito	
tрнL	Propagation Delay Time	A to B	Push-pull Driving	5.6	5	5	ns	
ΨΠL	High-to-low Output	A to B	Open-drain Driving	7.5	7.9	8.3	10	
<b>t</b>	Propagation Delay Time	A to B	Push-pull Driving	10.0	9.5	9	ns	
tplh	low-to-high Output	Alob	Open-drain Driving	181	170	154	115	
tрнL	Propagation Delay Time	B to A	Push-pull Driving	7	7.1	7.2		
4PHL	High-to-low Output		Open-drain Driving	7.6	8.1	9.2	ns	
tецн	Propagation Delay Time	B to A	Push-pull Driving	7.6	6.9	6	ns	
	low-to-high Output		Open-drain Driving	163	145	118		
t <sub>en</sub>	Enable Time		OE to A or B	135	159	182	ns	
t <sub>dis</sub>	Disable Time		OE to A or B	170	174	181	ns	
	luce t Die e Trees	A port	Push-pull Driving	13.4	11.9	10.6		
t <sub>r</sub> A	Input Rise Time	rise time	Open-drain Driving	68	66	62	ns	
tв	Input Rise Time	B port	Push-pull Driving	13	12	11.6	ns	
чВ	input ruse nine	rise time	Open-drain Driving	66	65	50	115	
t <sub>f</sub> A	Input Fall Time	A port fall	Push-pull Driving	5.6	4.7	4.0	ns	
цА		time	Open-drain Driving	5.0	5.1	5.2	115	
t <sub>fB</sub>	Input Fall Time	B port fall	Push-pull Driving	3.0	3.0	2.9	ns	
чв	input an time	time Open-drain Driving		6.1	5.6	4.4	no	
tsк(o)	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	0.5	ns	
Ma	uvimum Nata Rate		Push-pull Driving	22	23	24	Mbr	
Maximum Data Rate			Open-drain Driving		2	2	Mbps	



# Switching Characteristics:Vcc=2.5V±0.15V

over operating free-air temperature range (unless otherwise noted)

	Parameter		Conditions	$V_{\text{ccB}}\text{=}2.5V{\pm}0.2V$	$V_{ccB}$ =3.3V $\pm$ 0.2V	$V_{ccB}$ =5V $\pm$ 0.2V	Units	
	Farameter		Conditions	Тур	Тур	Тур	Units	
tрн	Propagation Delay Time	A to B	Push-pull Driving	3.5	3.5	3.2	ns	
PHL	High-to-low Output	Alob	Open-drain Driving	6.3	6.5	6.7	115	
	Propagation Delay Time	A to D	Push-pull Driving	4.5	4.9	4.7		
tplh	low-to-high Output	A to B	Open-drain Driving	158	152	142	ns	
tрн∟	Propagation Delay Time	B to A	Push-pull Driving	3.7	3.9	4.6		
ΨHL	High-to-low Output	DIOA	Open-drain Driving	6	6.6	7.7	ns	
telh	Propagation Delay Time	B to A	Push-pull Driving	4.8	4	2.5	ns	
IPLH	low-to-high Output	BIOA	Open-drain Driving	153	138	116	115	
t <sub>en</sub>	Enable Time		OE to A or B	7.7	41.8	130	ns	
t <sub>dis</sub>	Disable Time		OE to A or B	175	181	182	ns	
t <sub>rA</sub>	Input Rise Time	A port	Push-pull Driving	9.8	8.6	7.5	ns	
UrA.		Rise Time	Open-drain Driving	79	77	65	115	
	Input Rise Time	B port	Push-pull Driving	9.8	8.7	8.1	20	
tв	Input Rise Time	Rise Time	Open-drain Driving	93	68	53	ns	
tra	Input Fall Time	A port Fall	Push-pull Driving	4.6	4.1	3.6	20	
lfA	input raii fiine	Time	Open-drain Driving	5.1	5.1	5.2	ns	
tв	Input Fall Time	B port Fall	Push-pull Driving	4.5	4.0	4.0	20	
чв		Time	Open-drain Driving	6.9	7.4	7.8	ns	
tsк(o)	Skew(time), Output	Cha	annel-to-Channel Skew	0.5	0.5	0.5	ns	
Ма	ximum Data Rate		Push-pull Driving	22	24	24	Mhne	
ivia			Open-drain Driving		2	2	Mbps	





# Switching Characteristics:Vcc=3.3V±0.15V

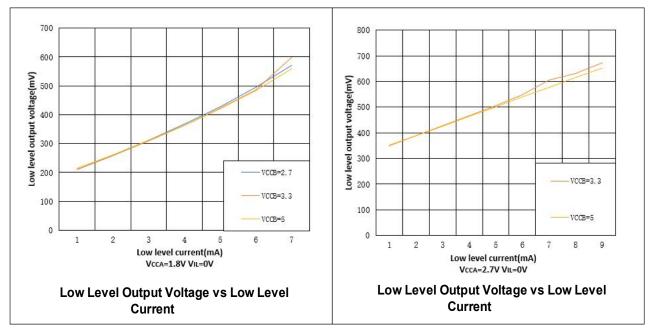
over recommended operating free-air temperature range (unless otherwise noted)

	Parameter		Conditions	$V_{ccB}$ =3.3V $\pm$ 0.2V	$V_{ccB}$ =5V $\pm$ 0.2V	Units
	Faiametei		Conditions	ТҮР	TYP	Units
ten.	Propagation Delay Time	A to B	Push-pull Driving	2.1	2.2	ns
PHL	High-to-low Output	Alob	Open-drain Driving	5.9	6.1	115
	Propagation Delay Time		Push-pull Driving	1	3.3	
ĺplh	High-to-low Output	A to B	Open-drain Driving	138	131	ns
	Propagation Delay Time	B to A	Push-pull Driving	2.3	2.6	
tphl	High-to-low Output	BIOA	Open-drain Driving	5.4	6.6	ns
t <sub>PLH</sub>	Propagation delay time	B to A	Push-pull Driving	1.0	1.0	ns
	low-to-high Output		Open-drain Driving	133	115	
t <sub>en</sub>	Enable Time		OE to A or B	4.7	5.2	ns
t <sub>dis</sub>	Disable Time		OE to A or B	174	182	ns
	Input Rise Time	A port	Push-pull Driving	7.4	6.6	20
t <sub>r</sub> A	input Rise filme	Rise Time	Open-drain Driving	75	67	ns
tв	Input Rise Time	B port	Push-pull Driving	7.7	7.1	ns
чв	input Nise Time	Rise Time	Open-drain Driving	70	65	115
t <sub>fA</sub>	Input Fall Time	A port Fall	Push-pull Driving	3.4	3.0	ns
ца		Time	Open-drain Driving	5.1	5.1	115
tв	Input Fall Time	B port Fall	Push-pull Driving	3.5	3.2	ns
чв		Time	Open-drain Driving	6.8	6.7	113
tsĸ(o)	Skew(time), Output	Cha	annel-to-Channel Skew	0.5	0.5	ns
M	aximum Data Rate		Push-pull Driving		24	Mbp
Maximum Data Rate			Open-drain Driving		2	ivibp





**Typical Characteristics** 

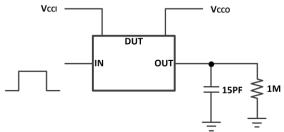


## Parameter Measurement Information

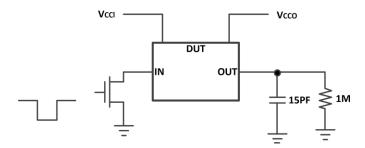
Unless otherwise noted, all input pulsed are supplied by generators having the following characteristics:

- PSRR 10MHz
- Zo=50 Ω
- dv/dt  $\geq$ 1V/ns

Note: All input pulses are measured one at a time with one transition per measurement



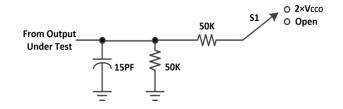
Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using a Push-Pull Driver



Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using an Open-Drain Driver



## Parameter Measurement Information (Continued)



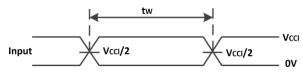
### Load Circuit for Enable/Disable Time Measurement

#### Switch Configuration for Enable/Disable Timing

Test	S1
tpzL <sup>(1)</sup> , tpLz <sup>(2)</sup>	2×Vcco
tрнzl <sup>(1)</sup> , tрzн <sup>(2)</sup>	Open

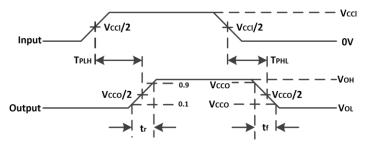
(1)  $t_{\text{PZL}}$  and  $t_{\text{PZH}}$  are the same as ten.

(2)  $t_{PLZ}$  and  $t_{PHZ}$  are the same as tdis.

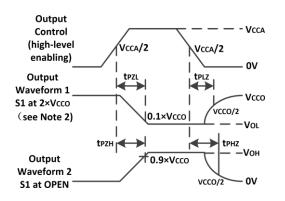


(1) All input pulses are measured one at a time, with one transition per measurement.

#### Voltage Waveforms Pulse Duration



#### **Voltage Waveforms Propagation Delay Times**



#### Voltage Waveforms Enable and Disable

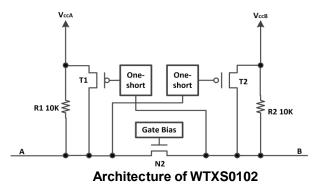


### Overview

The WTXS0102 IC is a Bi-direction voltage-level translator specifically designed for translating logic voltage levels. The A port can accept I/O voltages that cover from 1.65 V to 3.6 V range; The B port can accept I/O voltages from 2.3 V to 5.5 V. The device is a pass-gate architecture with edge-rate accelerators (one-shots) to improve the overall data rate. 10-k $\Omega$  pullup resistors that usually used in open-drain applications have been integrated inside IC with the advantage saving an external resistor. Not only the IC is designed for open-drain applications, but also this device can translate push-pull CMOS logic outputs.

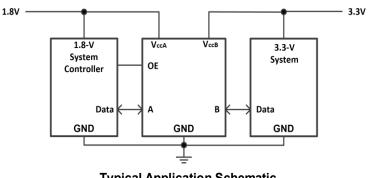
### Architecture

The WTXS0102 architecture (see Figure below) is a translator with Bi-direction-Sensing function that means a directioncontrol mechanism to control the direction of data flow from A to B or from B to A is not needed. These two bidirectional channels independently determine the direction of data flow without a direction-control signal. This autodirection feature is realized by each I/O pin can be automatically reconfigured as either an input or an output.



## **Application Information**

The WTXS0102 device can be used to bridge the digital-switching compatibility gap between two voltage nodes to successfully interface logic threshold levels found in electronic systems. It should be used in a point-to-point topology for interfacing devices or systems operating at different interface voltages with one another. Its primary target application use is for interfacing with open-drain drivers on the data I/Os such as I2C or 1-wire, where the data is bidirectional and no control signal is available. The device can also be used in applications where a push-pull driver is connected to the data I/Os, but the WTXS0108E might be a better option for such push-pull applications.

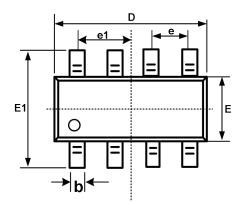


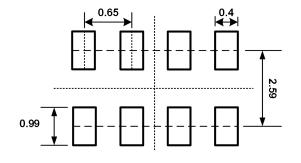
**Typical Application Schematic** 



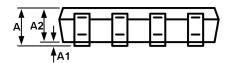


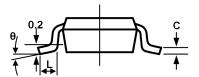
Package Outline Dimension SOT23-8





Recommended Land Pattern (Unit: mm)





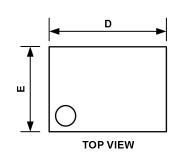
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Мах	Min	Мах
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.650BSC		0.026BSC	
e1	0.975BSC		0.038BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

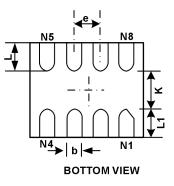


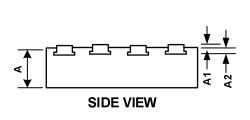


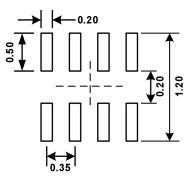
Package Outline Dimension

DFN1.4\*1-8L









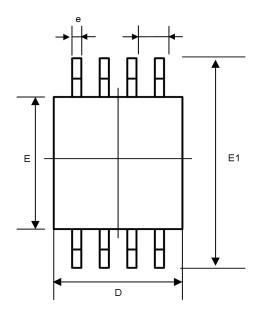
RECOMMENDED LAND PATTERN (Unit:mm)

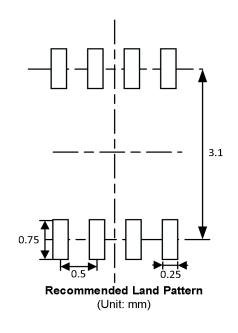
Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Мах	Min	Max
A	0.340	0.400	0.013	0.016
A1	0.000	0.050	0.000	0.002
A2	0.110REF		0.004REF	
D	1.350	1.450	0.053	0.057
E	0.950	1.050	0.037	0.041
k	0.200MIN		0.008MIN	
b	0.150	0.200	0.006	0.008
е	0.350TYP		0.014TYP	
L	0.250	0.350	0.010	0.014
L1	0.350	0.450	0.014	0.018

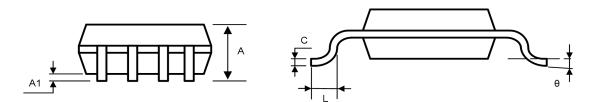




Package Outline Dimension VSSOP-8







Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Мах	Min	Мах
A	0.600	0.900	0.024	0.085
A1	0.000	0.100	0.000	0.004
b	0.170	0.250	0.007	0.010
С	0.100	0.200	0.004	0.008
D	1.900	2.100	0.075	0.083
е	0.500(BSC)		0.020(BSC)	
E1	3.000	3.200	0.118	0.126
E	2.200	2.400	0.087	0.095
L	0.200	0.350	0.008	0.014
θ	0°	6°	0°	6°



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